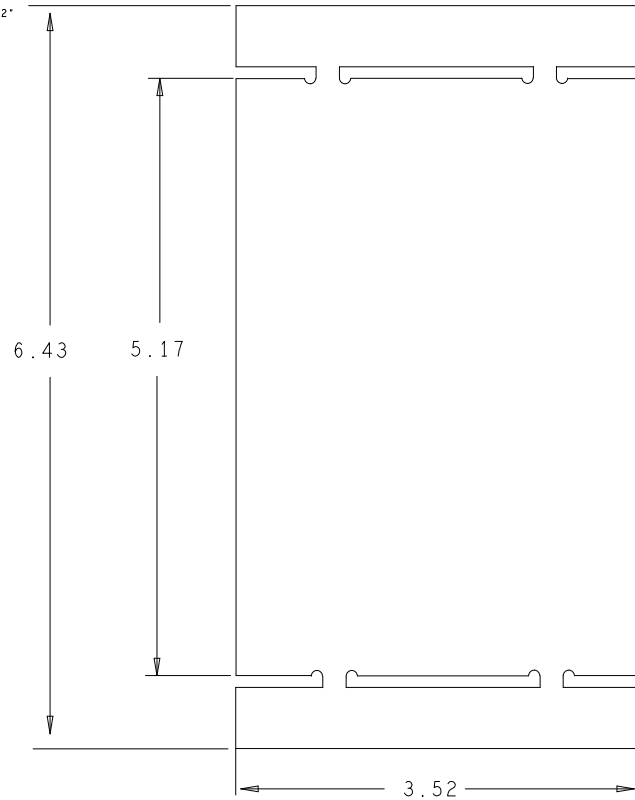


- 1 - Material FR-4, Rating 94V-0 Minimum Epoxy Glass Laminate. See Cross-section Drawing for Overall Thickness.
- 2 - Board shall be LPI Solder Masked Over Bare Copper Both Sides. Color Green.
- 3 - Silk-screen shall be Permanent Non-Conductive Ink and not Overlap on any Component Pad. Color White.
- 4 - All holes to be 0.002" of their True Position
- 5 - Minimum Annular Ring over Finished Hole Size: 0.002"
- 6 - Remove Sharp Edges 0.003" Maximum
- 7 - All dimensions in inches.
- 8 - This is an 4 LAYER Board.

- 9 - Finished Conductor Width shall not exceed +/- 10% from Artwork Master.
- 10- Any logotype from the manufacturer added to the board will not be conductive (Silkscreen)
- 11- The UL marker, as well as the PCB material (94V-0) will be written also in a non conductive layer (Silkscreen)
- 12- The manufacturing date will be written in the silkscreen (non conductive) (Month / Year). Example: 02/05



STACK UP	
59.1 MILS	PRE-PREG 4 MILS
	CORE 47 MILS
	PRE-PREG 4 MILS
LAYER 1-TOP 1/2 Oz.Cu. (0.67 MILS)	
LAYER 2-GND 1 Oz.Cu. (1.38 MILS)	
LAYER 3-PWR 1 Oz.Cu. (1.38 MILS)	
LAYER 4-BOTTOM 1/2 Oz.Cu. (0.67 MILS)	
ADDED MICRAGE ON EXTERNAL LAYERS 35um	

UNLESS OTHERWISE SPECIFIED	SIGNATURES	DATE	COMPANY NAME AND ADDRESS			
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS + 3 PL DECIMALS + ANGLES + FRACTIONS +			CORINEX Global, a.s.			
			Ruzova dolina 19			
			821 08 Bratislava			
			Slovak Republic			
			SIZE	FSCM NO	DWG NO	CXP/C-AV-M01_v1.0
			SCALE			SHEET

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED